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**SUGAHARA et al.**(10) **Pub. No.: US 2023/0232589 A1**(43) **Pub. Date: Jul. 20, 2023**(54) **ELECTRONIC CONTROL DEVICE**(86) PCT No.: **PCT/JP2021/019180**(71) Applicants: **Hitachi Astemo, Ltd.**, Hitachinaka-shi,  
Ibaraki (JP); **HITACHI, LTD.**, Tokyo  
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(2013.01)(57) **ABSTRACT**

An electronic control device includes a housing including a first region in which heat dissipation fins are formed on one side and an electronic component generating the largest amount of heat is in thermal contact with the other side, and a second region in which an electronic component is in thermal contact with the one side and the other side.

(73) Assignee: **Hitachi Astemo, Ltd.**, Hitachinaka-shi,  
Ibaraki (JP)(21) Appl. No.: **18/009,911**(22) PCT Filed: **May 20, 2021**